

Solid Tantalum Chip Capacitors, MICROTAN®, High CV Leadframeless Molded Automotive Grade



FEATURES

- Highest capacitance-voltage product in industry in given case size
- Small sizes include 0603 footprint
- Lead (Pb)-free L-shaped terminations
- AEC-Q200 qualified. PPAP available upon request
- 8 mm tape and reel packaging available per EIA-481
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS
COMPLIANT
HALOGEN
FREE
GREEN

(5-2008)

PERFORMANCE/ELECTRICAL CHARACTERISTICS

www.vishay.com/doc?40215

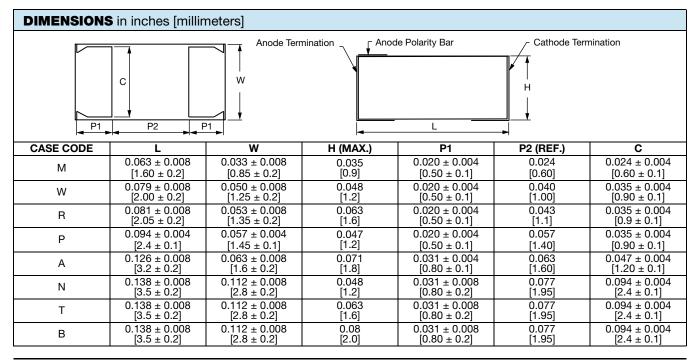
Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required)

Capacitance Range: 1.0 μ F to 100 μ F Capacitance Tolerance: \pm 10 %, \pm 20 % Voltage Rating: 6.3 V_{DC} to 40 V_{DC}

| ORDERING INFORMATION | | | | | | | |
|----------------------|---|--|---|---|---|--|--|
| TP8 TYPE | M CASE CODE See Ratings and Case Codes table. | This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow. | M CAPACITANCE TOLERANCE K = ± 10 % M = ± 20 % | DC VOLTAGE RATING AT +85 °C This is expressed in V. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V). | C TERMINATION/ PACKAGING C = 100 % tin 7" [178 mm] reel | | |

Note

• We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size. Voltage substitutions will be marked with the higher voltage rating.

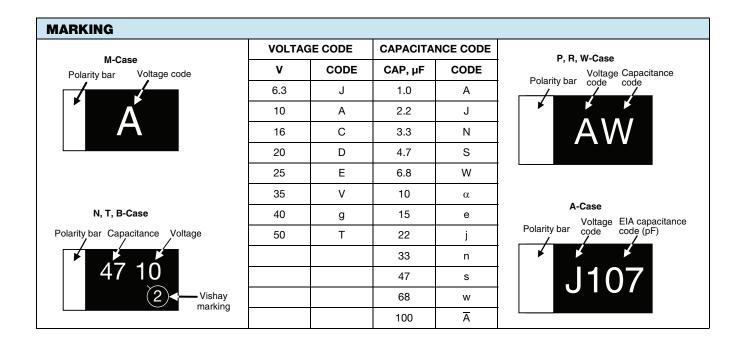


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Vishay Sprague

| RATINGS AN | D CASE CODE | S | | | | |
|------------|-------------|------|------|------|------|------|
| μF | 6.3 V | 10 V | 16 V | 20 V | 25 V | 40 V |
| 1.0 | | М | М | M/W | R | Р |
| 2.2 | | | М | | | |
| 3.3 | | М | | R | | |
| 4.7 | М | М | | Р | Р | |
| 6.8 | | W | | N/B | | |
| 10 | М | R | A/R | Α | | |
| 15 | | R | | | | |
| 22 | | А | | | | |
| 47 | | T/B | | | | |
| 100 | А | | | | | |





| STANDARD | RATINGS | | | | | |
|---------------------|-----------|-----------------------------|--------------------------------|---------------------------------------|---|---|
| CAPACITANCE (μF) | CASE CODE | PART NUMBER | MAX. DCL AT +25 °C (μA) | MAX. DF AT +25 °C 120 Hz (%) | MAX. ESR AT +25 °C 100 kHz (Ω) | MAX. RIPPLE 100 kHz I _{RMS} (A) |
| | | 6.3 V _{DC} AT +85 | °C; 4 V _{DC} AT +125 | °C | | |
| 4.7 | М | TP8M475M6R3C | 0.50 | 8 | 6 | 0.06 |
| 10 | М | TP8M106M6R3C | 0.63 | 8 | 5 | 0.07 |
| 100 | Α | TP8A107(1)6R3C | 6.30 | 30 | 3 | 0.16 |
| | | 10 V _{DC} AT +85 | °C; 7 V _{DC} AT +125 | °C | | |
| 1.0 | М | TP8M105M010C | 0.50 | 6 | 12 | 0.05 |
| 3.3 | М | TP8M335(1)010C | 0.50 | 8 | 6 | 0.06 |
| 4.7 | М | TP8M475M010C | 0.50 | 8 | 6 | 0.06 |
| 6.8 | W | TP8W685(1)010C | 0.68 | 8 | 8 | 0.06 |
| 10 | R | TP8R106(1)010C | 1.00 | 8 | 8 | 0.08 |
| 15 | R | TP8R156(1)010C | 1.50 | 8 | 5 | 0.09 |
| 22 | Α | TP8A226(1)010C | 2.20 | 8 | 8 | 0.10 |
| 47 | В | TP8B476(1)010C | 4.70 | 8 | 2 | 0.20 |
| 47 | Т | TP8T476(1)010C | 4.70 | 8 | 1 | 0.29 |
| | | 16 V _{DC} AT +85 | °C; 10 V _{DC} AT +125 | °C | | |
| 1.0 | М | TP8M105M016C | 0.50 | 6 | 12 | 0.05 |
| 2.2 | М | TP8M225M016C | 0.50 | 10 | 12 | 0.05 |
| 10 | Α | TP8A106(1)016C | 1.60 | 8 | 6 | 0.11 |
| 10 | R | TP8R106(1)016C | 1.60 | 8 | 8 | 0.08 |
| | | 20 V _{DC} AT +85 | °C; 13 V _{DC} AT +125 | °C | | |
| 1.0 | М | TP8M105M020C | 0.50 | 6 | 12 | 0.05 |
| 1.0 | W | TP8W105M020C | 0.50 | 8 | 8 | 0.06 |
| 3.3 | R | TP8R335(1)020C | 0.70 | 8 | 8 | 0.08 |
| 4.7 | Р | TP8P475(1)020C | 0.90 | 6 | 6 | 0.09 |
| 6.8 | В | TP8B685(1)020C | 1.36 | 8 | 6 | 0.12 |
| 6.8 | N | TP8N685(1)020C | 1.36 | 8 | 6 | 0.11 |
| 10 | Α | TP8A106(1)020C | 2.00 | 8 | 3 | 0.16 |
| | | 25 V _{DC} AT +85 | °C; 17 V _{DC} AT +125 | °C | | |
| 1.0 | R | TP8R105(1)025C | 0.50 | 6 | 10 | 0.07 |
| 4.7 | Р | TP8P475(1)025C | 1.20 | 6 | 6 | 0.09 |
| | | 40 V _{DC} AT +85 ° | °C; 28 V _{DC} AT +125 | °C | | |
| 1.0 | Р | TP8P105(1)040C | 0.50 | 8 | 10 | 0.07 |

[•] Part number definition:

⁽¹⁾ Tolerance: For 10 % tolerance, specify "K"; for 20 % tolerance, change to "M"



| AEC-Q200 QUALIFIC | CATION TESTING | |
|-------------------|--------------------------------------|---------------|
| NO. | AEC-Q200 TEST ITEM | REFERENCE |
| 1 | Pre- and post stress electrical test | Internal spec |
| 3 | High temperature exposure (storage) | AEC-Q200 |
| 4 | Temperature cycling | AEC-Q200 |
| 7 | Biased humidity | AEC-Q200 |
| 8 | Operational life | AEC-Q200 |
| 9 | External visual | AEC-Q200 |
| 10 | Physical dimension | AEC-Q200 |
| 12 | Resistance to solvents | AEC-Q200 |
| 13 | Mechanical shock | AEC-Q200 |
| 14 | Vibration | AEC-Q200 |
| 15 | Resistance to soldering heat | AEC-Q200 |
| 17 | ESD | AEC-Q200 |
| 18 | Solderability (1) | AEC-Q200 |
| 19 | Electrical characterization | Internal spec |
| 22 | Terminal strength (SMD) | AEC-Q200 |

⁽¹⁾ Exception: Instead of Solder Bath/Dip and Look Test (J-STD-002, method B at 215 °C, category 3) was performed "Method 2 - Surface Mount Process Simulation Test" per JESD22-B102E as specified in AEC-Q005 REV-A.

| STANDARD PACKAGING QUANTITY | | | | | |
|-----------------------------|---------------------|--|--|--|--|
| CASE CODE | QUANTITY (pcs/reel) | | | | |
| CASE CODE | 7" REEL | | | | |
| M | 4000 | | | | |
| W | 2500 | | | | |
| R | 2500 | | | | |
| Р | 3000 | | | | |
| A | 2000 | | | | |
| N | 2500 | | | | |
| Т | 2500 | | | | |
| В | 2000 | | | | |

| POWER DISSIPATION | |
|-------------------|--|
| CASE CODE | MAXIMUM PERMISSIBLE POWER DISSIPATION AT +25 °C (W) IN FREE AIR |
| M | 0.025 |
| W | 0.040 |
| R | 0.045 |
| Р | 0.045 |
| A | 0.075 |
| N | 0.075 |
| Т | 0.084 |
| В | 0.085 |

| PRODUCT INFORMATION | |
|-------------------------------|--------------------------|
| Micro Guide | www.vishay.com/doc?40115 |
| Moisture Sensitivity | www.vishay.com/doc?40135 |
| SELECTOR GUIDES | |
| Solid Tantalum Selector Guide | www.vishay.com/doc?49053 |
| FAQ | |
| Frequently Asked Questions | www.vishay.com/doc?40110 |

Guide for Leadframeless Molded Tantalum Capacitors

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum / tantalum oxide / manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance / volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance / volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

| COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS | | | | | |
|--|--------------------------|--|--|--|--|
| DIELECTRIC | e DIELECTRIC CONSTANT | | | | |
| Air or Vacuum | 1.0 | | | | |
| Paper | 2.0 to 6.0 | | | | |
| Plastic | 2.1 to 6.0 | | | | |
| Mineral Oil | 2.2 to 2.3 | | | | |
| Silicone Oil | 2.7 to 2.8 | | | | |
| Quartz | 3.8 to 4.4 | | | | |
| Glass | 4.8 to 8.0 | | | | |
| Porcelain | 5.1 to 5.9 | | | | |
| Mica | 5.4 to 8.7 | | | | |
| Aluminum Oxide | 8.4 | | | | |
| Tantalum Pentoxide | 26 | | | | |
| Ceramic | 12 to 400K | | | | |

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

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SOLID ELECTROLYTE TANTALUM CAPACITORS

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the leadframe.

Molded chip tantalum capacitor encases the element in plastic resins, such as epoxy materials. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost.

Surface mount designs of "Solid Tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.

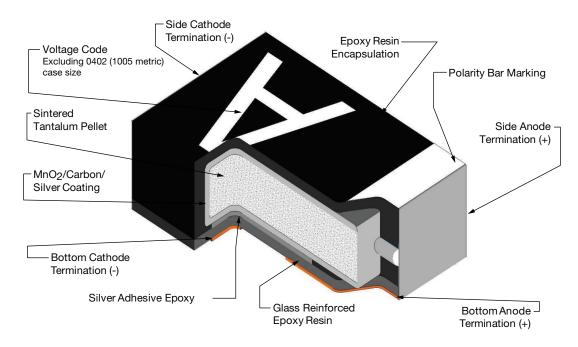


Fig. 1 - Leadframeless Molded Capacitors, All Types



| SOLID TANTALUM CA | PACITORS - LEADE | RAMELESS MOLD | ED | | | | |
|-----------------------|---|-------------------|---|---|--|--|--|
| SERIES | TL8 | 298D | 298W | TR8 | | | |
| PRODUCT IMAGE | | | | | | | |
| TYPE | Solid tantalum leadframeless molded chip capacitors | | | | | | |
| | Small size including 0603 and 0402 foot print | | | | | | |
| FEATURES | Ultra low profile | Industrial grade | Industrial grade, extended range | Low ESR | | | |
| TEMPERATURE RANGE | TEMPERATURE RANGE Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required) | | Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required) | Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required) | | | |
| CAPACITANCE RANGE | 0.68 μF to 220 μF | 0.33 μF to 220 μF | 2.2 μF to 220 μF | 1 μF to 220 μF | | | |
| VOLTAGE RANGE | 4 V to 25 V | 2.5 V to 50 V | 4 V to 16 V | 2.5 V to 25 V | | | |
| CAPACITANCE TOLERANCE | ERANCE ± 20 %, ± 10 % | | | | | | |
| DISSIPATION FACTOR | DISSIPATION FACTOR 6 % to 80 % | | 30 % to 80 % | 6 % to 80 % | | | |
| CASE CODES | W9, A0, B0 K, M, R, P, Q, A, S, B K, M, Q M, R, P | | | | | | |
| TERMINATION | 100 % tin | | 100 % tin or gold plated | | | | |

| SOLID TANTALUM CA | PACITORS - LEADI | FRAMELESS MOLD | ED | | | |
|-----------------------|---|---|---|---------------------------------------|--|--|
| SERIES | TP8 | TM8 | DLA 11020 | T42 | | |
| PRODUCT IMAGE | | | | | | |
| TYPE | | Solid tantalum leadframele | ss molded chip capacitors | | | |
| FEATURES | Small siz | Built in fuse, double-stacked | | | | |
| FEATURES | High performance, automotive grade | High reliability | High reliability, DLA approved | High reliability, ultra-low ESR | | |
| TEMPERATURE RANGE | -55 | Operating T o °C to +125 °C (above 85 °C | emperature: C, voltage derating is requi | red) | | |
| CAPACITANCE RANGE | 1 μF to 100 μF | 0.68 μF to 47 μF | 1 μF to 47 μF | 10 μF to 470 μF | | |
| VOLTAGE RANGE | 6.3 V to 40 V | 2 V to 40 V | 6.3 V to 40 V | 16 V to 75 V | | |
| CAPACITANCE TOLERANCE | ± 20 %, ± 10 % | | | | | |
| DISSIPATION FACTOR | FION FACTOR 6 % to 30 % | | 6 % to 8 % | 6 % to 15 % | | |
| CASE CODES | M, W, R, P, A, N, T, B K, M, G, W, R, P, A, | | M, W, R, P, A, N, T | M2 | | |
| TERMINATION | 100 % tin | Tin / lead solder plated, 100 % tin and gold plated | Tin / lead solder plated or gold plated | Tin / lead solder plated or 100 % tin | | |

available on plastic embossed tape per EIA-481.

Standard reel diameter is 7" [178 mm].



PLASTIC TAPE AND REEL PACKAGING in inches [millimeters] 0.157 ± 0.004 10 pitches cumulative $[4.0 \pm 0.10]$ tolerance on tape Tape thickness Deformation ± 0.008 [0.200] 0.059 + 0.004 - 0.0 between [1.5 + 0.10 - 0.0]Embossment 0.014 embossments 0.079 ± 0.002 0.069 ± 0.004 [0.35] $[2.0 \pm 0.05]$ (1.75 ± 0.10) max. Top cover ¥ 0.030 [0.75] tape min. (3) W B₄ (max.) Maximum component 0.030 [0.75] rotation Top cover min. (4) tape (Side or front sectional view) Center lines For tape feeder 0.004 [0.10] D₁ (min.) for components of cavity $0.079 \times 0.047 [2.0 \times 1.2]$ and larger $^{(5)}$ reference only max **USER DIRECTION** including draft. Maximum OF FEED Concentric around B₀ (5) cavity size (1) Cathode (-) O 0 0 DIRECTION OF FEED 3.937 [100.0] 20° maximum 0.039 [1.0] component rotation Typical component Tape and Reel Specifications: all case sizes are

Notes

(Top view)

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

0.039 [1.0]

0.9843 [250.0]

Camber

(Top view)

Allowable camber to be 0.039/3.937 [1/100]

Non-cumulative over 9.843 [250.0]

- Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide 'R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less

 This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier
- tape between the embossed cavity or to the edge of the cavity whichever is less
- The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- B₁ dimension is a reference dimension tape feeder clearance only

cavity

Typical

center line

component

center line

| CARRIER TA | APE DIMENS | SIONS in inche | es [millimeters] | FOR 298D, | 298W, TR8, | TP8, TL8 | |
|------------------|------------|--------------------------------------|-----------------------|-------------|-----------------------|----------------|--------------|
| CASE CODE | TAPE SIZE | B ₁ (MAX.) ⁽¹⁾ | D ₁ (MIN.) | F | K ₀ (MAX.) | P ₁ | W |
| M ⁽²⁾ | 8 mm | 0.075 [1.91] | 0.02 [0.5] | 0.138 [3.5] | 0.043 [1.10] | 0.157 [4.0] | 0.315 [8.0] |
| W | 8 mm | 0.112 [2.85] | 0.039 [1.0] | 0.138 [3.5] | 0.053 [1.35] | 0.157 [4.0] | 0.315 [8.0] |
| R | 8 mm | 0.098 [2.46] | 0.039 [1.0] | 0.138 [3.5] | 0.066 [1.71] | 0.157 [4.0] | 0.315 [8.0] |
| Р | 8 mm | 0.108 [2.75] | 0.02 [0.5] | 0.138 [3.5] | 0.054 [1.37] | 0.157 [4.0] | 0.315 [8.0] |
| Α | 8 mm | 0.153 [3.90] | 0.039 [1.0] | 0.138 [3.5] | 0.078 [2.00] | 0.157 [4.0] | 0.315 [8.0] |
| A0, Q | 8 mm | - | 0.02 [0.5] | 0.138 [3.5] | 0.049 [1.25] | 0.157 [4.0] | 0.315 [8.0] |
| В | 8 mm | 0.157 [4.0] | 0.039 [1.0] | 0.138 [3.5] | 0.087[2.22] | 0.157 [4.0] | 0.315 [8.0] |
| W9, S | 8 mm | 0.126 [3.20] | 0.029 [0.75] | 0.138 [3.5] | 0.045 [1.15] | 0.157 [4.0] | 0.315 [8.0] |
| B0 | 12 mm | 0.181 [4.61] | 0.059 [1.5] | 0.217 [5.5] | 0.049 [1.25] | 0.157 [4.0] | 0.472 [12.0] |

Notes

- For reference only
- (2) Packaging of M case in plastic tape is available per request



Vishay Sprague

| CARRIER TA | APE DIMENS | IONS in inche | s [millimeters] | FOR TM8 | | | |
|------------|------------|--------------------------------------|-----------------------|-------------|-----------------------|----------------|--------------|
| CASE CODE | TAPE SIZE | B ₁ (MAX.) ⁽¹⁾ | D ₁ (MIN.) | F | K ₀ (MAX.) | P ₁ | w |
| М | 8 mm | 0.075 [1.91] | 0.02 [0.5] | 0.138 [3.5] | 0.043 [1.10] | 0.157 [4.0] | 0.315 [8.0] |
| G | 8 mm | 0.077 [1.96] | 0.02 [0.5] | 0.138 [3.5] | 0.051 [1.30] | 0.157 [4.0] | 0.315 [8.0] |
| W | 8 mm | 0.112 [2.85] | 0.039 [1.0] | 0.138 [3.5] | 0.053 [1.35] | 0.157 [4.0] | 0.315 [8.0] |
| R | 8 mm | 0.098 [2.46] | 0.039 [1.0] | 0.138 [3.5] | 0.066 [1.71] | 0.157 [4.0] | 0.315 [8.0] |
| Р | 8 mm | 0.108 [2.75] | 0.02 [0.5] | 0.138 [3.5] | 0.054 [1.37] | 0.157 [4.0] | 0.315 [8.0] |
| Α | 8 mm | 0.153 [3.90] | 0.039 [1.0] | 0.138 [3.5] | 0.078 [2.00] | 0.157 [4.0] | 0.315 [8.0] |
| N | 12 mm | 0.154 [3.90] | 0.059 [1.5] | 0.216 [5.5] | 0.051 [1.30] | 0.157 [4.0] | 0.472 [12.0] |
| Т | 12 mm | 0.154 [3.90] | 0.059 [1.5] | 0.216 [5.5] | 0.067 [1.70] | 0.157 [4.0] | 0.472 [12.0] |

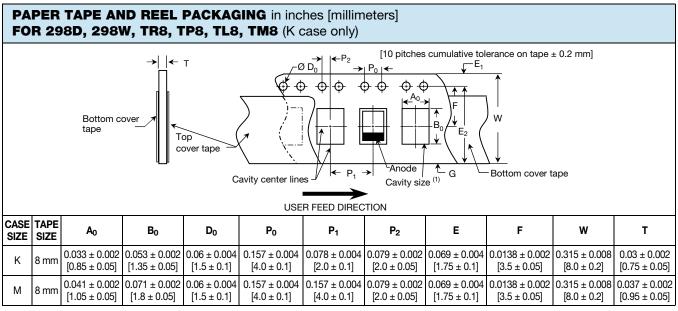
Notes

⁽¹⁾ For reference only

| CARRIER TAPE DIMENSIONS in inches [millimeters] FOR T42 | | | | | | | |
|---|-----------|--------------------------------------|-----------------------|-------------|-----------------------|----------------|--------------|
| CASE CODE | TAPE SIZE | B ₁ (MAX.) ⁽¹⁾ | D ₁ (MIN.) | F | K ₀ (MAX.) | P ₁ | W |
| M2 | 16 mm | 0.404 [10.3] | 0.059 [1.5] | 0.295 [7.5] | 0.176 [4.5] | 0.472 [12.0] | 0.630 [16.0] |

Note

(1) For reference only

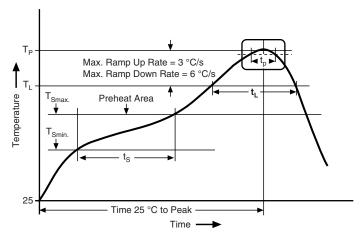


⁽¹⁾ A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

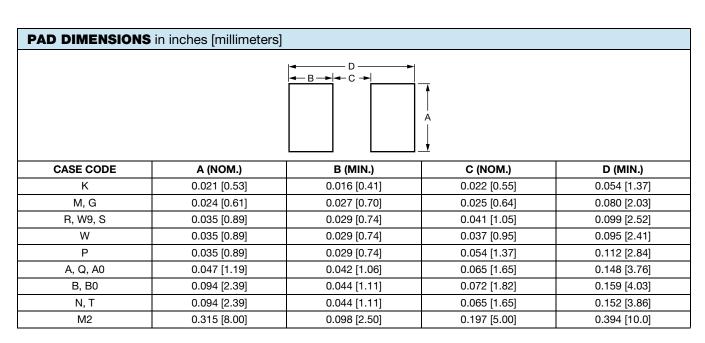


RECOMMENDED REFLOW PROFILES

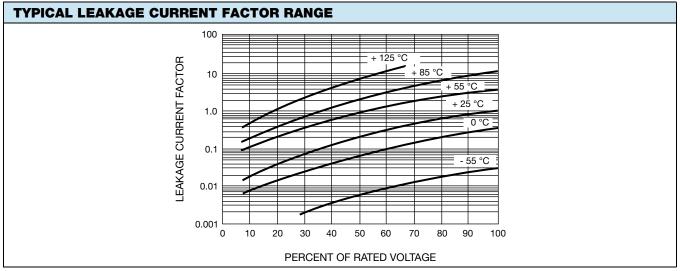
Capacitors should withstand reflow profile as per J-STD-020 standard, three cycles.



| PROFILE FEATURE | SnPb EUTECTIC ASSEMBLY | LEAD (Pb)-FREE ASSEMBLY | |
|---|------------------------|-------------------------|--|
| PREHEAT AND SOAK | | | |
| Temperature min. (T _{Smin.}) | 100 °C | 150 °C | |
| Temperature max. (T _{Smax.}) | 150 °C | 200 °C | |
| Time (t _S) from (T _{Smin.} to T _{Smax.}) | 60 s to 90 s | 60 s to 150 s | |
| RAMP UP | | | |
| Ramp-up rate (T _L to T _p) | 3 °C/s maximum | | |
| Liquidus temperature (T _L) | 183 °C | 217 °C | |
| Time (t _L) maintained above T _L | 60 s to 150 s | | |
| Peak package body temperature (T _p) max. | 235 °C | 260 °C | |
| Time (t _p) within 5 °C of the peak max. temperature | 20 s | 30 s | |
| RAMP DOWN | | | |
| Ramp-down rate (T _p to T _L) | 6 °C/s r | naximum | |
| Time from 25 °C to peak temperature | 6 min maximum | 8 min maximum | |

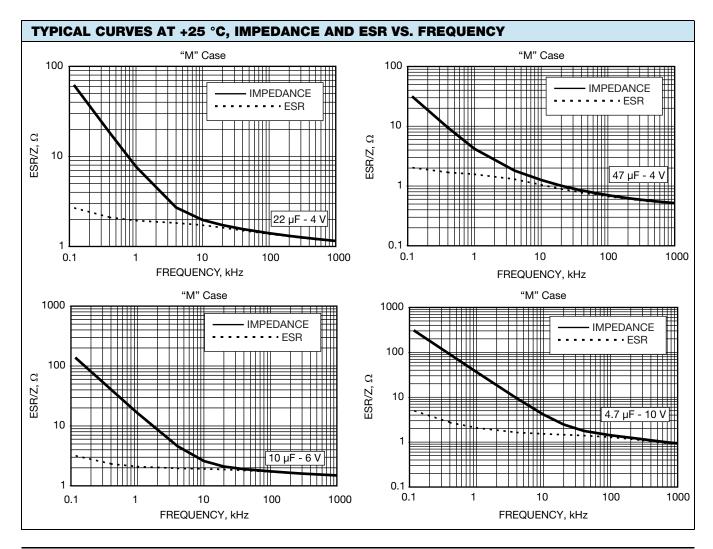






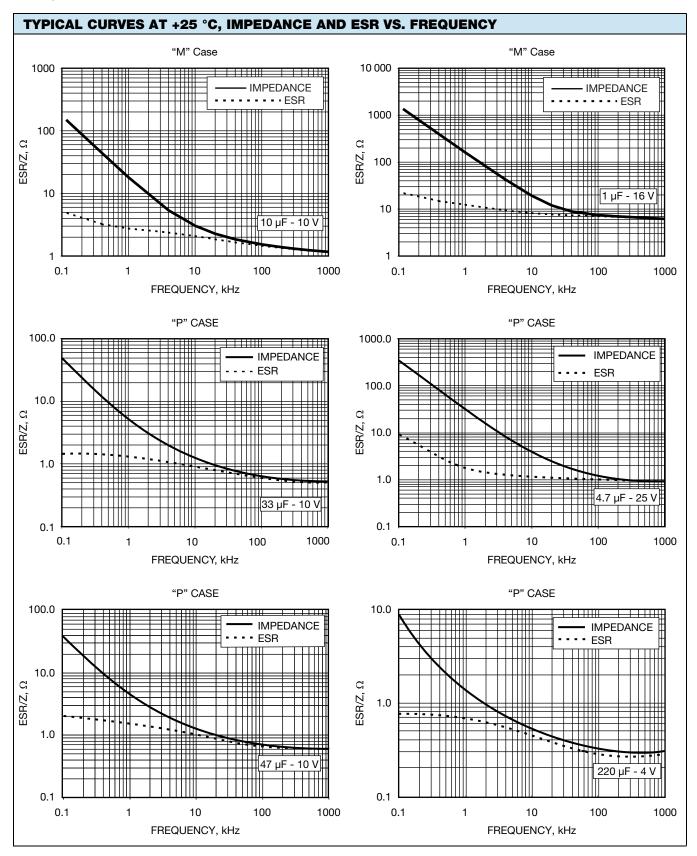
Notes

- At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table
- At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table
- At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table









Vishay Sprague

GUIDE TO APPLICATION

 AC Ripple Current: the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{\text{RMS}} \, = \, Z \sqrt{\frac{P}{R_{\text{ESR}}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

Z = the capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at +25 °C.
- 3. **Reverse Voltage:** these capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at +25 °C, 5 % of the DC rating at +25 °C, 5 % of the DC rating at +85 °C, and 1 % of the DC rating at +125 °C.
- 4. **Temperature Derating:** if these capacitors are to be operated at temperatures above +25 °C, the permissible RMS ripple current shall be calculated using the derating factors as shown:

| TEMPERATURE | DERATING FACTOR |
|-------------|-----------------|
| +25 °C | 1.0 |
| +85 °C | 0.9 |
| +125 °C | 0.4 |

5. Power Dissipation: power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using +25 °C temperature rise.)

- 6. **Printed Circuit Board Materials:** molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).
- 7. Attachment:
- 7.1 **Solder Paste:** the recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.
- 7.2.1 Backward and Forward Compatibility: capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC / ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/I at 40 kHz for 2 min.
- 9. Recommended Mounting Pad Geometries: proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and / or circuit board design.



Vishay Sprague

Molded Chip Tantalum Capacitors, Automotive Grade

| ELECTRICAL PERFO | RMANCE CHAR | ACTERISTICS | | | |
|---------------------------------------|---|-----------------------|----------------------------|-------------------|----------------------------|
| ITEM | PERFORMANCE CHARACTERISTICS | | | | |
| Category temperature range | $^-55$ °C to $_+85$ °C (to $_+150$ °C / $_+175$ °C with voltage derating - refer to graph "Category Voltage vs. Temperature") $^{(1)}$ | | | | |
| Capacitance tolerance | ± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz | | | | |
| Dissipation factor | Limits per Standard | Ratings table. Tested | via bridge method, at | t 25 °C, 120 Hz | |
| ESR | | Ratings table. Tested | | | |
| Leakage current | After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 kΩ resistor in series with the capacitor under test, leakage current at 25 °C is not more than 0.01 CV or 0.5 μA, whichever is greater. Note that the leakage current varies with temperature and applied voltage. See graph "Typical Leakage Current Temperature Factor" for the appropriate adjustment factor. | | | | |
| Capacitance change by temperature | +30 % max. (at +175 °C) +20 % max. (at +125 °C and +150 °C) +10 % max. (at +85 °C) -10 % max. (at -55 °C) | | | | |
| Reverse voltage | Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at +25 °C 5 % of the DC rating at +85 °C 1 % of the DC rating at +125 °C | | | | |
| Ripple current | For maximum ripple current values (at 25 °C) refer to relevant datasheet. If capacitors are to be used at temperatures above +25 °C, the permissible RMS ripple current (or voltage) shall be calculated using the derating factors: 1.0 at +25 °C 0.9 at +85 °C 0.4 at +125 °C 0.3 at +150 °C 0.2 at +175 °C | | | | |
| Maximum operating | +85 °C | | +125 °C | | +150 °C / +175 °C |
| and surge voltages vs. temperature | RATED VOLTAGE (V) | SURGE VOLTAGE (V) | CATEGORY VOLTAGE (V) | SURGE VOLTAGE (V) | CATEGORY VOLTAGE (V) |
| | 4 | 5.2 | 2.7 | 3.4 | n/a |
| | 6.3 | 8 | 4 | 5 | 3 |
| | 10 | 13 | 7 | 8 | 5 |
| | 16 | 20 | 10 | 12 | 8 |
| | 20 | 26 | 13 | 16 | 10 |
| | 25 32 17 20 12.5 | | | | |
| | 35 | 46 | 23 | 28 | 17.5 |
| | 50 | 65 | 33 | 40 | 25 |
| | 50 ⁽²⁾ | 60 | 33 | 40 | n/a |
| | 63 | 75 | 42 | 50 | n/a |
| | 75 ⁽³⁾ | 75 | 50 | 50 | n/a |

Notes

- All information presented in this document reflects typical performance characteristics
- (1) Series TH3 up to 150 °C; TH4 up to 175 °C
- (2) Capacitance value 15 µF and higher
- (3) For 293D and TR3 only

| RECOMMENDED VOLTAGE DERATING GUIDELINES (for temperature below +85 °C) | | | | |
|--|----------------------------|--|--|--|
| VOLTAGE RAIL | CAPACITOR VOLTAGE RATING | | | |
| ≤ 3.3 | 6.3 | | | |
| 5 | 10 | | | |
| 10 | 20 | | | |
| 12 | 25 | | | |
| 15 | 35 | | | |
| ≥ 24 | 50 or series configuration | | | |

Note

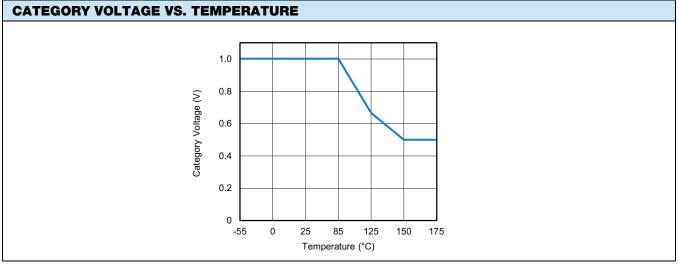
• For temperatures above +85 °C the same voltage derating ratio is recommended, but with respect to category voltage.

Up to +85 °C: category voltage = rated voltage At +125 °C: category voltage = 2/3 of rated voltage

At 150 °C / 175 °C: category voltage = 1/2 of rated voltage

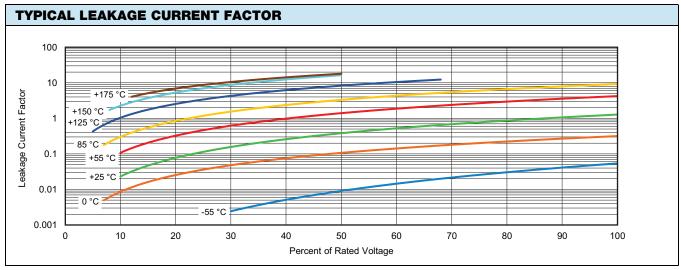
Revision: 07-Feb-2019 1 Document Number: 40215

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Note

· Below 85 °C category voltage is equal to rated voltage



- At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
 - At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table.
- At +150 °C, the leakage current shall not exceed 15 times the value listed in the Standard Ratings table.
- At +175 °C, the leakage current shall not exceed 18 times the value listed in the Standard Ratings table

Typical Performance Characteristics

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| ITEM | CONDITION | | POST TEST PERFORMANCE | | |
|--|--|--|--|--|--|
| High temperature exposure (storage) | MIL-STD-202, method 108 1000 h, at maximum rated temperature, unpowered | Capacitance change Dissipation factor Leakage current ESR | Within ± 20 % of initial value Initial specified limit Initial specified limit Initial specified limit | | |
| Operational life test at +125 °C | AEC-Q200 1000 h application 2/3 of rated voltage | Capacitance change Dissipation factor Leakage current ESR | Within ± 20 % of initial value Initial specified limit Shall not exceed 10 times the initial limit Initial specified limit | | |
| Operational life test at +150 °C (for TH3) and at +175 °C (for TH4) | AEC-Q200 1000 h application 1/2 of rated voltage | Capacitance change Dissipation factor Leakage current ESR | Within ± 20 % of initial value Shall not exceed 3 times the initial limit Shall not exceed 10 times the initial limit Shall not exceed 3 times the initial limit | | |
| Surge voltage | MIL-PRF-55365: 1000 successive test cycles at 85 °C of surge voltage (as specified in the table above), in series with a 33 Ω resistor at the rate of 30 s ON, 30 s OFF | Capacitance change Dissipation factor Leakage current ESR | Within ± 30 % of initial value Shall not exceed 1.5 times the initial limit Shall not exceed 2 times the initial limit Shall not exceed 1.5 times the initial limit | | |
| Biased humidity test | AEC-Q200 At 85 °C / 85 % RH, 1000 h, with rated voltage applied | Capacitance change Dissipation factor Leakage current ESR | Within ± 20 % of initial value Shall not exceed 3 times the initial limit Shall not exceed 10 times the initial limit Shall not exceed 3 times the initial limit | | |
| Temperature cycling | AEC-Q200 / JESD22, method JA-104 -55 °C / +125 °C, for 1000 cycles | Capacitance change Dissipation factor Leakage current ESR | Within ± 20 % of initial value Initial specified limit Initial specified limit Initial specified limit | | |

| MECHANICAL | PERFORMANCE CHARACTERISTICS | | |
|---|--|--|--|
| ITEM | CONDITION | POST TEST PERFORMANCE | |
| Vibration | MIL-STD-202, method 204: 10 Hz to 2000 Hz, 5 g peak for 20 min, 12 cycles each of 3 orientations (total 36 cycles), at rated voltage | Capacitance change Within ± 20 % of initial value Dissipation factor Initial specified limit Leakage current Initial specified limit | |
| | | There shall be no mechanical or visual damage to capacitors post-conditioning. | |
| Mechanical shock | MIL-STD-202, method 213, condition F, 1500 <i>g</i> peak, 0.5 ms, half-sine | Capacitance change Within ± 20 % of initial value Dissipation factor Initial specified limit Leakage current Initial specified limit | |
| | | There shall be no mechanical or visual damage to capacitors post-conditioning. | |
| Resistance to solder heat | MIL-STD-202, method 210, condition D Solder dip 260 °C ± 5 °C, 10 s | Capacitance change Within ± 20 % of initial value Dissipation factor Initial specified limit Leakage current Initial specified limit | |
| Resistance to solvents | MIL-STD-202, method 215 | Capacitance change Within ± 20 % of initial value Dissipation factor Initial specified limit Leakage current Initial specified limit | |
| | | There shall be no mechanical or visual damage to capacitors post-conditioning. Body marking shall remain legible. | |
| Solderability | AEC-Q200 / J-STD-002 | Electrical test not required | |
| Terminal strength / Shear force test | AEC-Q200-006 Apply a pressure load of 17.7 N (1.8 kg) for 60 s horizontally to the center of capacitor side body Exception: for case size 0603 pressure load is 5N | Part should not be sheared off the pads and no body cracking post-conditioning. Electrical test not required. | |
| Flammability | Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 % | n/a | |



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